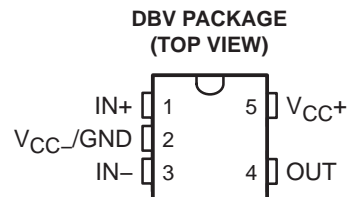


# TL343 SINGLE LOW-POWER OPERATIONAL AMPLIFIER

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- Wide Range of Supply Voltages, Single Supply 3 V to 30 V, or Dual Supplies
- Class AB Output Stage
- True Differential-Input Stage
- Low Input Bias Current
- Internal Frequency Compensation
- Short-Circuit Protection



## description/ordering information

The TL343 is a single operational amplifier similar in performance to the  $\mu$ A741, but with several distinct advantages. It is designed to operate from a single supply over a range of voltages from 3 V to 30 V. Operation from split supplies also is possible, provided the difference between the two supplies is 3 V to 30 V. The common-mode input range includes the negative supply. Output range is from the negative supply to  $V_{CC} - 1.5$  V.

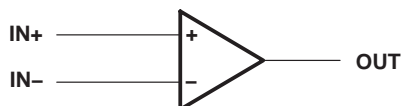
## ORDERING INFORMATION

$T_A$	$V_{IO\text{MAX}}$ AT 25°C	PACKAGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
–40°C to 125°C	10 mV	SOT-23-5 (DBV)	Reel of 3000	TL343IDBVR
			Reel of 250	TL343IDBVT
				T4I_

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

‡ The actual top-side marking has one additional character that designates the assembly/test site.

## symbol



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

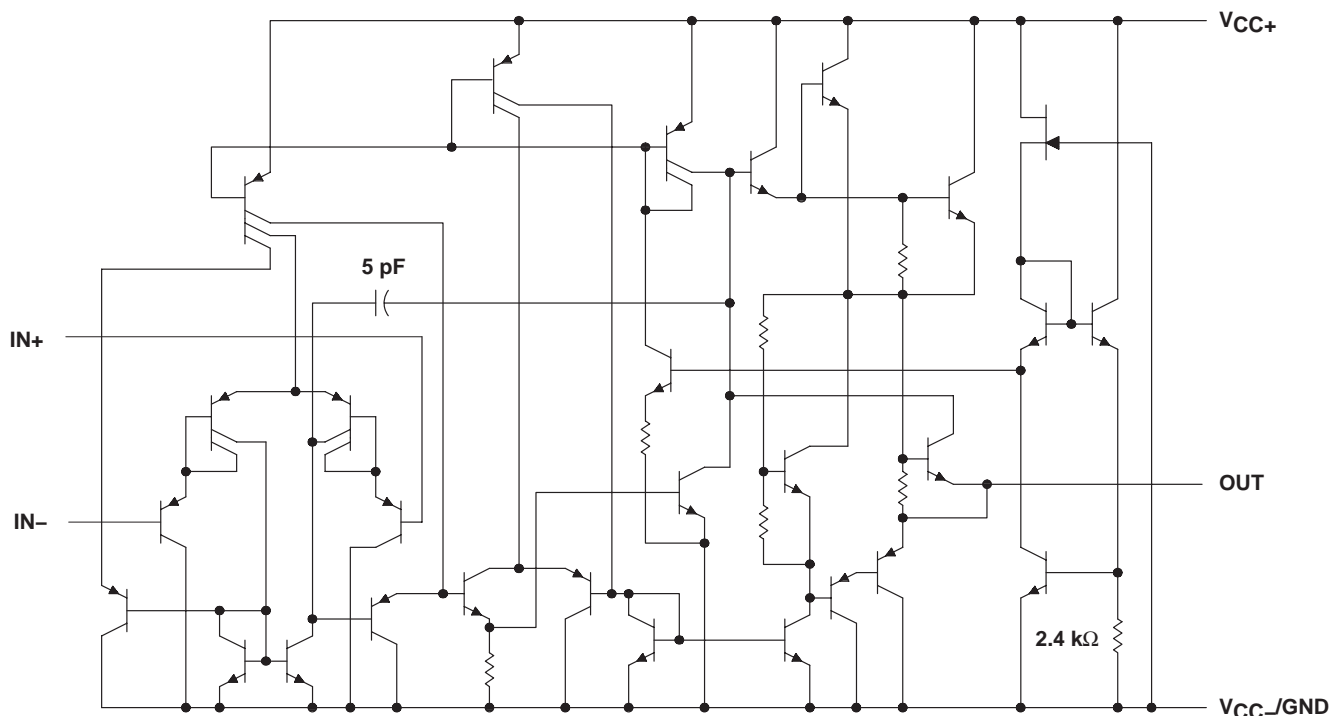
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# TL343 SINGLE LOW-POWER OPERATIONAL AMPLIFIER

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## schematic



NOTE A: Component values shown are nominal.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	MAX	UNIT
Supply voltage (see Note 1)	V <sub>CC+</sub>	18
	V <sub>CC-</sub>	-18
Supply voltage, V <sub>CC+</sub> with respect to V <sub>CC-</sub>	36	V
Differential input voltage (see Note 2)	±36	V
Input voltage (see Notes 1 and 3)	±18	V
Package thermal impedance, $\theta_{JA}$ (see Notes 4 and 5)	206	°C/W
Operating virtual junction temperature, T <sub>J</sub>	150	°C
Storage temperature range, T <sub>stg</sub>	-65 to 150	°C

- NOTES:
1. These voltage values are with respect to the midpoint between V<sub>CC+</sub> and V<sub>CC-</sub>.
  2. Differential voltages are at IN+ with respect to IN-.
  3. Neither input must ever be more positive than V<sub>CC+</sub> or more negative than V<sub>CC-</sub>.
  4. Maximum power dissipation is a function of T<sub>J(max)</sub>,  $\theta_{JA}$ , and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_{J(max)} - T_A) / \theta_{JA}$ . Selecting the maximum of 150°C can affect reliability.
  5. The package thermal impedance is calculated in accordance with JESD 51-7.

# TL343

## SINGLE LOW-POWER OPERATIONAL AMPLIFIER

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### recommended operating conditions

		MIN	MAX	UNIT
$V_{CC}$	Single-supply voltage	3	30	V
$V_{CC+}$	Dual-supply voltage	1.5	15	V
$V_{CC-}$		-1.5	-15	
$T_A$	Operating free-air temperature	-40	125	°C

### electrical characteristics at specified free-air temperature, $V_{CC\pm} = \pm 15$ V (unless otherwise noted)

PARAMETER	TEST CONDITION <sup>†</sup>	MIN	TYP	MAX	UNIT		
$V_{IO}$	Input offset voltage	See Note 6	25°C	2	10	mV	
			Full range		12		
$\alpha_{V_{IO}}$	Temperature coefficient of input offset voltage	See Note 6	Full range	10		$\mu\text{V}/^\circ\text{C}$	
$I_{IO}$	Input offset current	See Note 6	25°C	30	50	nA	
			Full range		200		
$\alpha_{I_{IO}}$	Temperature coefficient of input offset current	See Note 6	Full range	50		$\text{pA}/^\circ\text{C}$	
$I_{IB}$	Input bias current	See Note 6	25°C	-200	-500	nA	
			Full range		-800		
$V_{ICR}$	Common-mode input voltage range <sup>‡</sup>		25°C	$V_{CC-}$ to 13	$V_{CC-}$ to 13.5	V	
$V_{OM}$	Peak output-voltage swing	$R_L = 10\text{ k}\Omega$	25°C	$\pm 12$	$\pm 13.5$	V	
			25°C	$\pm 10$	$\pm 13$		
			Full range	$\pm 10$			
$A_{VD}$	Large-signal differential voltage amplification	$V_O = \pm 10\text{ V}$ , $R_L = 2\text{ k}\Omega$	25°C	20	200	V/mV	
			Full range	15			
$B_{OM}$	Maximum-output-swing bandwidth	$V_{OPP} = 20\text{ V}$ , THD $\leq 5\%$ , $R_L = 2\text{ k}\Omega$	25°C	9		kHz	
$B_1$	Unity-gain bandwidth	$V_O = 50\text{ mV}$ , $R_L = 10\text{ k}\Omega$	25°C	1		MHz	
$\phi_m$	Phase margin	$C_L = 200\text{ pF}$ , $R_L = 2\text{ k}\Omega$	25°C	44		Deg	
$r_i$	Input resistance	$f = 20\text{ Hz}$	25°C	0.3	1	$\text{M}\Omega$	
$r_o$	Output resistance	$f = 20\text{ Hz}$	25°C	75		$\Omega$	
CMRR	Common-mode rejection ratio	$V_{IC} = V_{ICR}(\text{min})$	25°C	70	90	dB	
$k_{SVS}$	Supply-voltage sensitivity ( $\Delta V_{IO}/\Delta V_{CC}$ )	$V_{CC\pm} = \pm 2.5$ to $\pm 15\text{ V}$	25°C	30	150	$\mu\text{V}/\text{V}$	
$I_{OS}$	Short-circuit output current <sup>§</sup>		25°C	$\pm 10$	$\pm 30$	$\pm 55$	mA
$I_{CC}$	Total supply current	No load, See Note 6	25°C	0.7	2.8	mA	

<sup>†</sup> All characteristics are measured under open-loop conditions, with zero common-mode voltage, unless otherwise specified. Full range for  $T_A$  is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

<sup>‡</sup> The  $V_{ICR}$  limits are linked directly, volt-for-volt, to supply voltage; the positive limit is 2 V less than  $V_{CC+}$ .

<sup>§</sup> Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.

NOTE 6:  $V_{IO}$ ,  $I_{IO}$ ,  $I_{IB}$ , and  $I_{CC}$  are defined at  $V_O = 0$ .

# TL343

## SINGLE LOW-POWER OPERATIONAL AMPLIFIER

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electrical characteristics,  $V_{CC+} = 3\text{ V}$  and  $5\text{ V}$ ,  $V_{CC-} = 0\text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITION†	MIN	TYP	MAX	UNIT
$V_{IO}$ Input offset voltage	$V_O = 1.5\text{ V}$ and $2.5\text{ V}$		2	10	mV
$I_{IO}$ Input offset current	$V_O = 1.5\text{ V}$ and $2.5\text{ V}$		30	50	nA
$I_{IB}$ Input bias current	$V_O = 1.5\text{ V}$ and $2.5\text{ V}$		-200	-500	nA
$V_{OM}$ Peak output voltage swing‡	$R_L = 10\text{ k}\Omega$	3.3	3.5		V
$A_{VD}$ Large-signal differential voltage amplification	$V_O = 1.7\text{ V}$ to $3.3\text{ V}$ , $R_L = 2\text{ k}\Omega$	20	200		V/mV
$k_{SVS}$ Supply-voltage sensitivity ( $\Delta V_{IO}/\Delta V_{CC\pm}$ )	$V_{CC\pm} = \pm 2.5\text{ V}$ to $\pm 15\text{ V}$			150	$\mu\text{V}/\text{V}$
$I_{CC}$ Supply current	$V_O = 1.5\text{ V}$ and $2.5\text{ V}$ , No load		0.7	1.75	mA

† All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified.

‡ Output swings essentially to ground.

operating characteristics,  $V_{CC\pm} = \pm 15\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $A_{VD} = 1$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TYP	UNIT
SR Slew rate at unity gain	$V_I = \pm 10\text{ V}$ , $C_L = 100\text{ pF}$ , $R_L = 2\text{ k}\Omega$ , See Figure 1	1	$\text{V}/\mu\text{s}$
$t_r$ Rise time	$\Delta V_O = 50\text{ mV}$ , $C_L = 100\text{ pF}$ , $R_L = 10\text{ k}\Omega$ , See Figure 1	0.35	$\mu\text{s}$
$t_f$ Fall time	$\Delta V_O = 50\text{ mV}$ , $C_L = 100\text{ pF}$ , $R_L = 10\text{ k}\Omega$ , See Figure 1	0.35	$\mu\text{s}$
Overshoot factor	$\Delta V_O = 50\text{ mV}$ , $C_L = 100\text{ pF}$ , $R_L = 10\text{ k}\Omega$ , See Figure 1	20%	
Crossover distortion	$V_{I(PP)} = 30\text{ mV}$ , $V_{OPP} = 2\text{ V}$ , $f = 10\text{ kHz}$	1%	

### PARAMETER MEASUREMENT INFORMATION

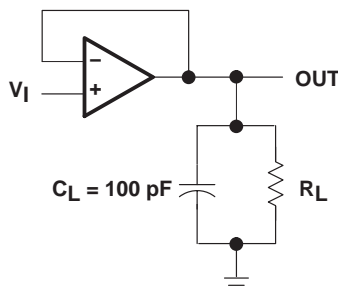


Figure 1. Unity-Gain Amplifier

TYPICAL CHARACTERISTICS†

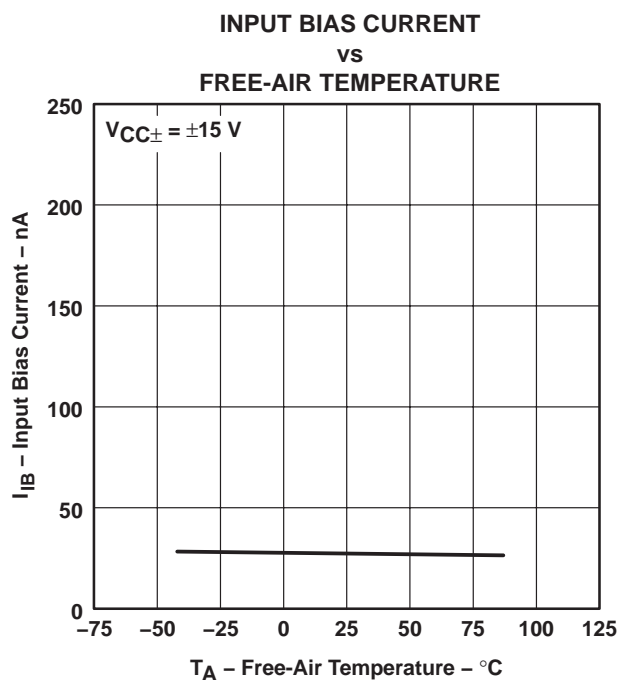


Figure 2

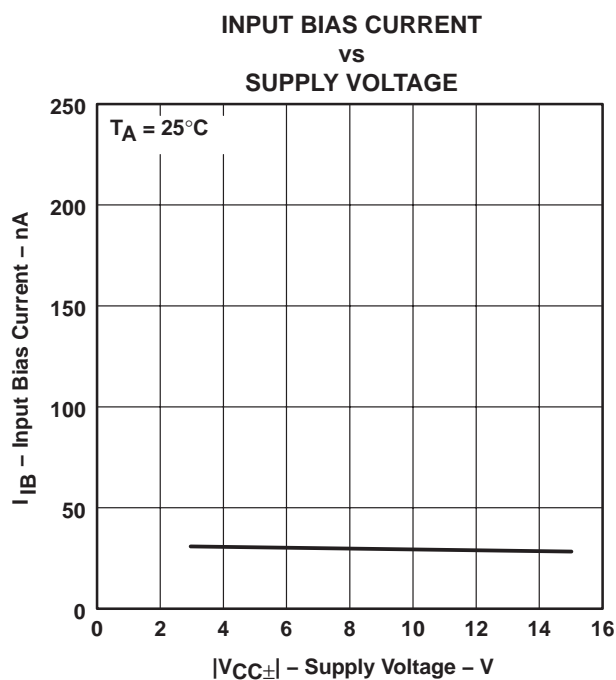


Figure 3

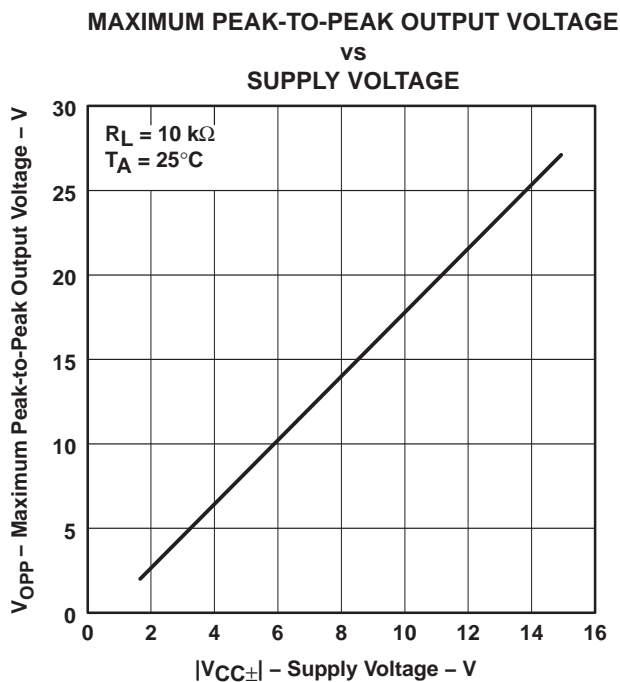


Figure 4

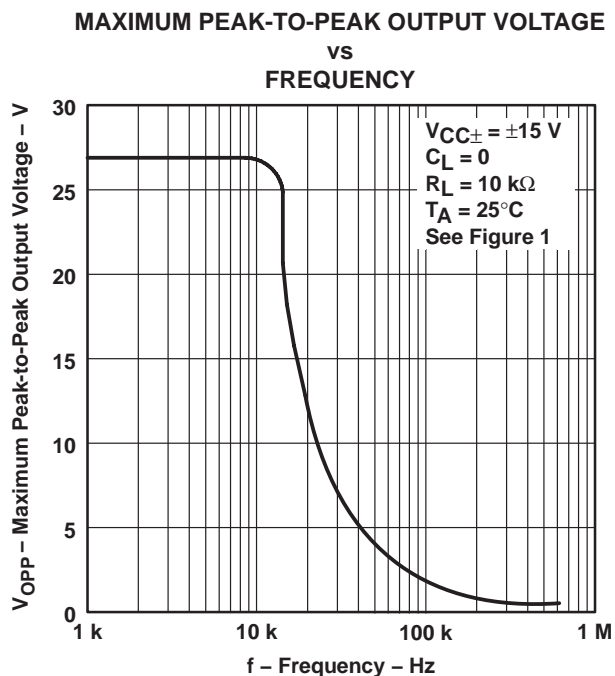


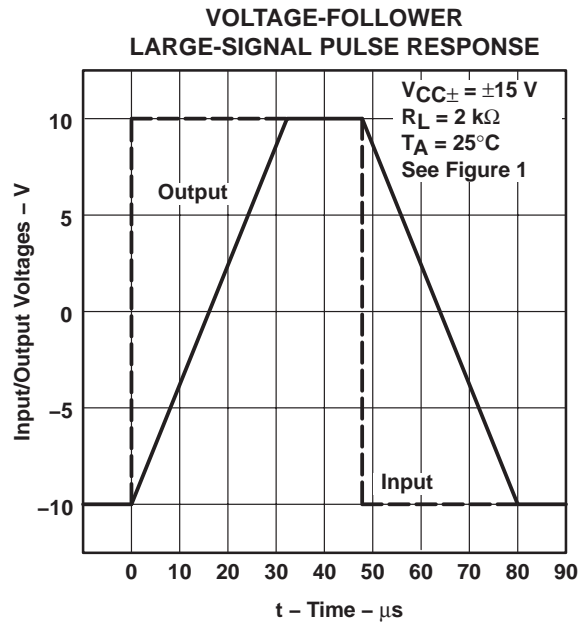
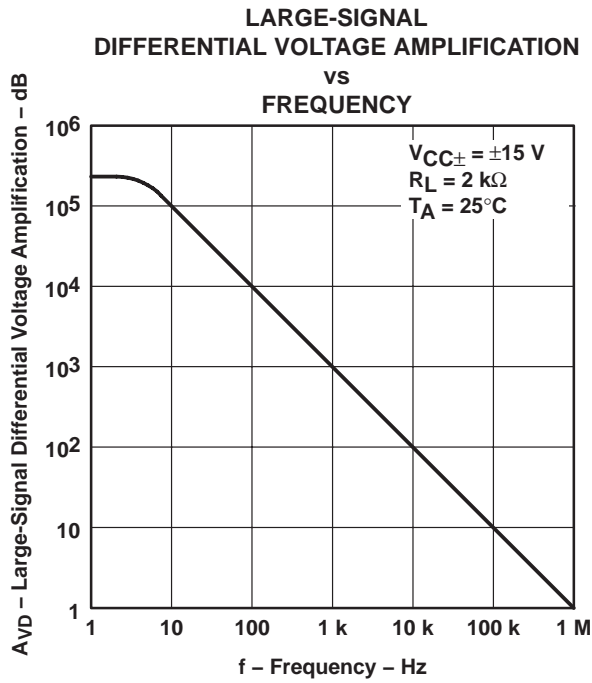
Figure 5

† Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

# TL343 SINGLE LOW-POWER OPERATIONAL AMPLIFIER

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## TYPICAL CHARACTERISTICS†



† Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TL3431DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL3431DBVRE4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL3431DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL3431DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL3431DBVTE4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL3431DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**

**REEL DIMENSIONS**



**TAPE DIMENSIONS**



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

**TAPE AND REEL INFORMATION**

\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL343IDBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
TL343IDBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TL343IDBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3



**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL343IDBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
TL343IDBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TL343IDBVT	SOT-23	DBV	5	250	205.0	200.0	33.0

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